



COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

Product Summary

Device	BV _{DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
		0.99Ω @ V _{GS} = 4.5V	455mA
04	201/	1.2Ω @ V _{GS} = 2.5V	414mA
Q1	20V	1.8Ω @ V _{GS} = 1.8V	338mA
		2.4Ω @ V _{GS} = 1.5V	292mA
	1.9Ω @ V _{GS} = -4.5V	-328mA	
00	001/	2.4Ω @ V _{GS} = -2.5V	-292mA
Q2	-20V	3.4Ω @ V _{GS} = -1.8V	-245mA
		5Ω @ V _{GS} = -1.5V	-202mA

Features and Benefits

- Low On-Resistance
- Very low Gate Threshold Voltage, 1.0V max
- Low Input Capacitance
- Fast Switching Speed
- Ultra-Small Surface Mount Package 0.8mm x 0.6mm
- Totally Lead-Free & Fully RoHS compliant (Note 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

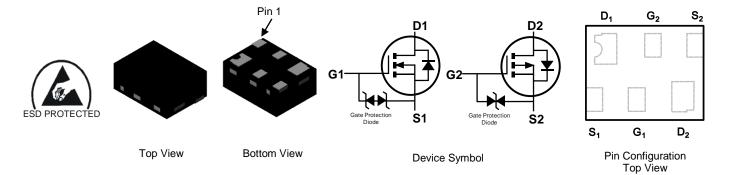
Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- General Purpose Interfacing Switch
- **Power Management Functions**
- **Analog Switch**

Mechanical Data

- Case: X2-DFN0806-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 63
- Weight: 0.027 grams (Approximate)



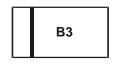
Ordering Information (Note 4)

	Part Number	Case	Packaging
۱	DMC21D1UDA-7B	X2-DFN0806-6	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain < 900ppm bromine, < 900ppm chlorine (< 1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



Top View

B3 = Product Type Marking Code

1 of 10 DMC21D1UDA Document number: DS39203 Rev. 1 - 2



Maximum Ratings Q1 N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	20	V
Gate-Source Voltage			V _{GSS}	±8	V
Continuous Drain Current (Note 5)	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	455 365	mA
Pulsed Drain Current (Note 6)			I _{DM}	1500	mA

Maximum Ratings Q2 P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V_{DSS}	-20	V
Gate-Source Voltage			V_{GSS}	±8	V
Continuous Drain Current (Note 5) $V_{GS} = -4.5V$ Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$			I _D	-328 -262	mA
Pulsed Drain Current (Note 6)			I _{DM}	-1000	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		P_{D}	300	mW
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	419	°C/W
Operating and Storage Temperature Range		$T_{J,}T_{STG}$	-55 to +150	°C

Notes: 5. Device mounted on FR-4 PCB, with minimum recommended pad layout.

Electrical Characteristics Q1 N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						•
Drain-Source Breakdown Voltage	BV _{DSS}	20	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current @T _C = +25°	C I _{DSS}	_	_	1	μΑ	$V_{DS} = 16V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 5V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	0.4	0.75	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
		_	0.5	0.99		$V_{GS} = 4.5V, I_D = 100mA$
Static Drain-Source On-Resistance		_	0.6	1.2	Ω	$V_{GS} = 2.5V, I_D = 50mA$
Static Drain-Source On-Resistance	R _{DS(ON)}	_	0.8	1.8	12	$V_{GS} = 1.8V, I_D = 20mA$
		_	1.0	2.4		$V_{GS} = 1.5V, I_D = 10mA$
Diode Forward Voltage	V _{SD}	_	0.6	1.0	V	$V_{GS} = 0V, I_{S} = 10mA$
DYNAMIC CHARACTERISTICS (Note 8)		•			•	•
Input Capacitance	C _{iss}	_	31	_	pF	\\\\ \A5\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\
Output Capacitance	Coss	_	3.6	_	pF	$V_{DS} = 15V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	2.6	_	pF	1 = 1.000112
Gate Resistance	R _G	_	113	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge	Qg	_	0.41	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$
Gate-Source Charge	Q _{qs}	_	0.06	_	nC	I _D = 250mA
Gate-Drain Charge	Q _{gd}	_	0.05	_	nC	
Turn-On Delay Time	t _{D(ON)}	_	4.5	_	ns	
Turn-On Rise Time	t _R	_	3.4	_	ns	V _{DD} = 15V, V _{GS} = 4.5V,
Turn-Off Delay Time		_	24	_	ns	$R_G = 2\Omega, I_D = 200 \text{mA}$
Turn-Off Fall Time	t _F	_	12	_	ns	1

^{6.} Device mounted on minimum recommended pad layout test board, 10µs pulse duty cycle = 1%.



Electrical Characteristics Q2 P-CHANNEL (@T_A = +25°C, unless otherwise specified.)

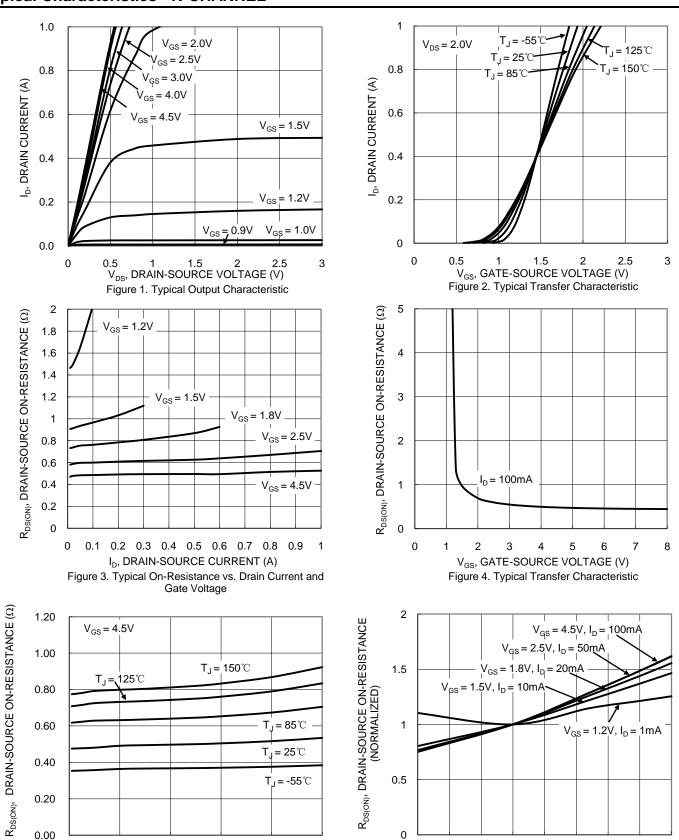
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_	_	V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current @T _C = +25	5°C I _{DSS}	_	_	-1	μΑ	$V_{DS} = -16V, V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 5V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	-0.4	-0.7	-1.0	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$
		_	1.2	1.9		$V_{GS} = -4.5V$, $I_D = -100mA$
Static Drain-Source On-Resistance	D	_	1.6	2.4	Ω	$V_{GS} = -2.5V, I_D = -50mA$
Static Dialit-Source Off-Resistance	R _{DS(ON)}	_	1.9	3.4	22	$V_{GS} = -1.8V, I_D = -20mA$
		_	2.4	5		$V_{GS} = -1.5V, I_D = -10mA$
Diode Forward Voltage	V _{SD}	_	-0.7	-1.1	V	$V_{GS} = 0V, I_{S} = -10mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	_	28.5	_	pF	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
Output Capacitance	Coss	_	3.9	_	pF	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	2.4	_	pF	1 = 1.000112
Gate Resistance	R _G	_	398	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$
Total Gate Charge	Qg	_	0.4	_	nC	V 45V V 40V
Gate-Source Charge	Qgs	_	0.07	_	nC	$V_{GS} = -4.5V, V_{DS} = -10V,$ $V_{DS} = -250 \text{mA}$
Gate-Drain Charge	Q_{gd}	_	0.07	_	nC	ID = -250IIIA
Turn-On Delay Time	t _{D(ON)}	_	5.2	_	ns	
Turn-On Rise Time	t _R	_	4.3	_	ns	$V_{DD} = -15V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t _{D(OFF)}	_	31	_	ns	$R_G = 2\Omega, I_D = -200 \text{mA}$
Turn-Off Fall Time	t _F	_	15.4	_	ns	

Notes:

^{7.} Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to product testing.



Typical Characteristics - N-CHANNEL



I_D, DRAIN CURRENT (A)
Figure 5. Typical On-Resistance vs. Drain Current and
Temperature
DMC21D1UDA
4

0.6

8.0

0.4

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125

150

100

-50

25

50

 $T_{J}, JUNCTION\ TEMPERATURE\ ({}^{\circ}\mathbb{C})$ Figure 6. On-Resistance Variation with Temperature

75

0

0.2



Typical Characteristics - N-CHANNEL (Cont.)

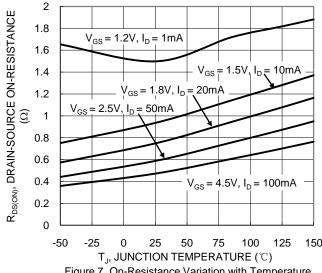
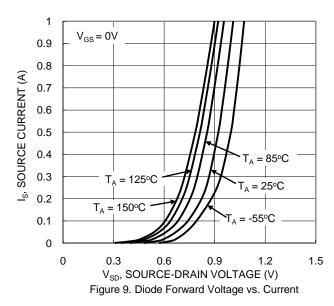
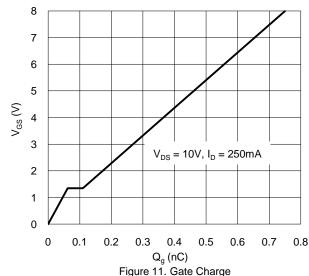
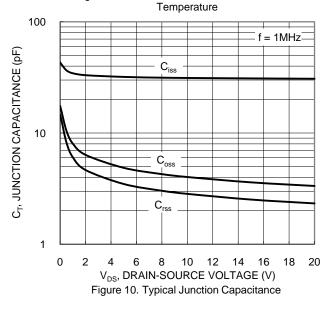


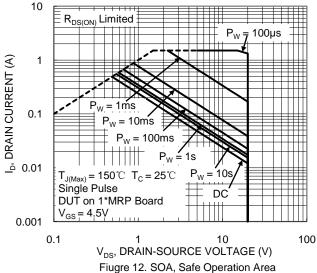
Figure 7. On-Resistance Variation with Temperature





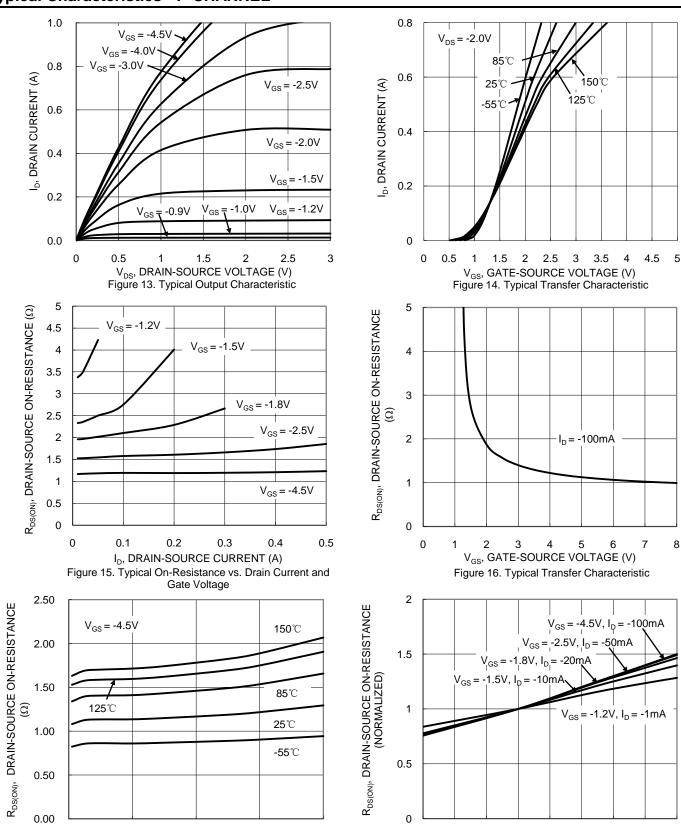
1 $V_{GS(TH)}$, GATE THRESHOLD VOLTAGE (V) $I_D = 1mA$ 8.0 $I_{D} = 250 \mu A$ 0.6 0.4 0.2 -50 -25 0 25 50 75 100 125 150 T_J , JUNCTION TEMPERATURE (°C) Figure 8. Gate Threshold Variation vs. Junction







Typical Characteristics - P-CHANNEL



0

0.4

I_D, DRAIN CURRENT (A)

Figure 17. Typical On-Resistance vs. Drain Current and

Temperature

0.6

-50

-25

0

25

50

T_J, JUNCTION TEMPERATURE (°C)

Figure 18. On-Resistance Variation with Temperature

75

100

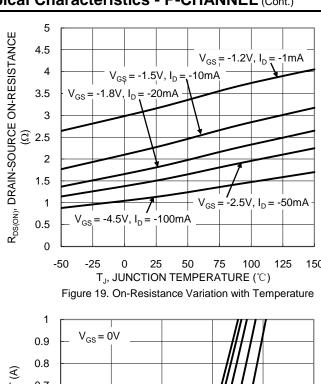
125

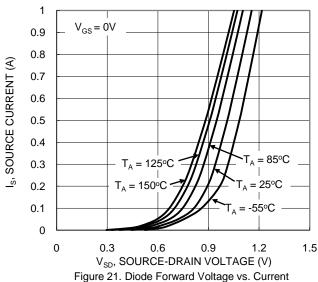
150

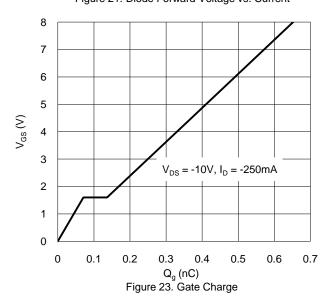
8.0

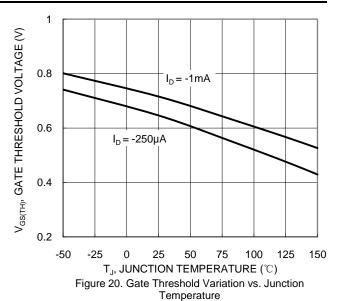


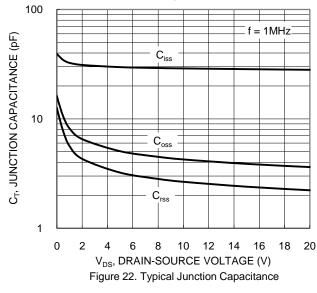
Typical Characteristics - P-CHANNEL (Cont.)

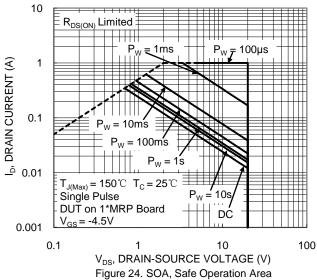














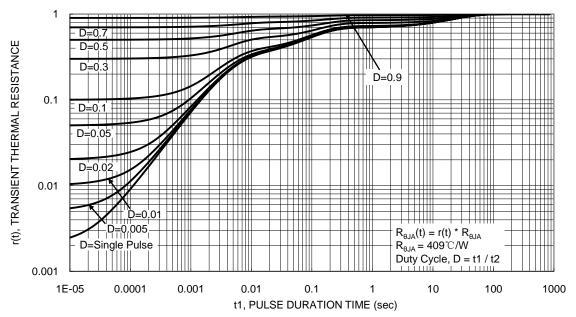


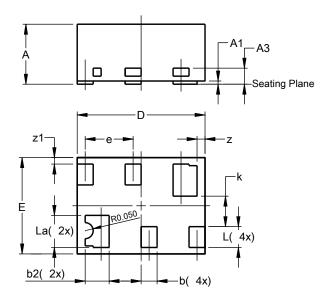
Figure 25. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN0806-6

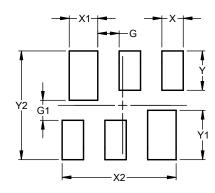


X2-DFN0806-6						
Dim	Min	Max	Тур			
Α		0.40	0.36			
A1	0.00	0.03	0.02			
A3			0.10			
b	0.07	0.15	0.10			
b2	0.10	0.20	0.15			
D	0.75	0.85	0.80			
E	0.55	0.65	0.60			
е			0.30			
k			0.19			
L	0.10	0.18	0.13			
La	0.17	0.25	0.20			
Z			0.05			
z1			0.04			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

X2-DFN0806-6



Dimensions	Value (in mm)
G	0.150
G1	0.140
X	0.150
X1	0.200
X2	0.800
Y	0.275
Y1	0.345
Y2	0.760



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